INTEGRATED CIRCUITS

DATA SHEET

74ABT16827A 74ABTH16827A

20-bit buffer/line driver, non-inverting (3-State)

Product specification
Supersedes data of 1995 Aug 31
IC23 Data Handbook





20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

FEATURES

- Multiple V_{CC} and GND pins minimize switching noise
- Live insertion/extraction permitted
- 3-State output buffers
- Power-up 3-State
- 74ABTH16827A incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Output capability: +64mA/-32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model

DESCRIPTION

The 74ABT16827A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16827A 20-bit buffers provide high performance bus interface buffering for wide data/address paths or buses carrying parity. They have NOR Output Enables (nOE1, nOE2) for maximum control flexibility.

Two options are available, 74ABT16827A which does not have the bus-hold feature and 74ABTH16827A which incorporates the bus-hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nAx to nYx	$C_L = 50pF; V_{CC} = 5V$	1.7 1.4	ns
C _{IN}	Input capacitance	$V_{I} = 0V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output capacitance	$V_O = 0V$ or V_{CC} ; 3-State	6	pF
I _{CCZ}	Quiescent supply current	Outputs disabled; $V_{CC} = 5.5V$	500	μΑ
I _{CCL}	жисэссти эцрру силети	Outputs Low; $V_{CC} = 5.5V$	9	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABT16827A DL	BT16827A DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABT16827A DGG	BT16827A DGG	SOT364-1
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABTH16827A DL	BH16827A DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABTH16827A DGG	BH16827A DGG	SOT364-1

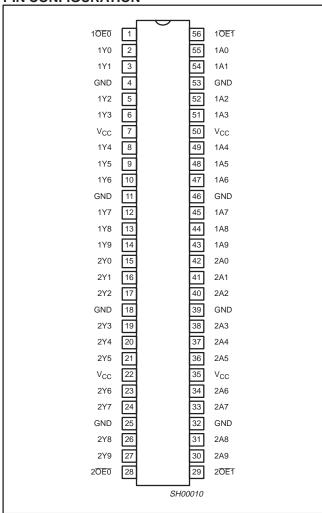
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31, 30	1A0 - 1A9 2A0 - 2A9	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26, 27	1Y0 - 1Y9 2Y0 - 2Y9	Data outputs
1, 56, 28, 29	1 <u>0</u> E0, 1 <u>0</u> E1 20E0, 20E1	Output enable inputs (active-Low)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

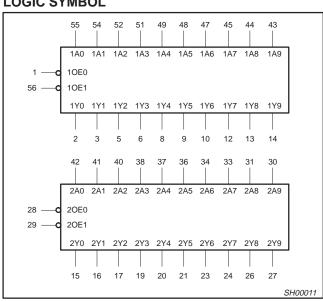
20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

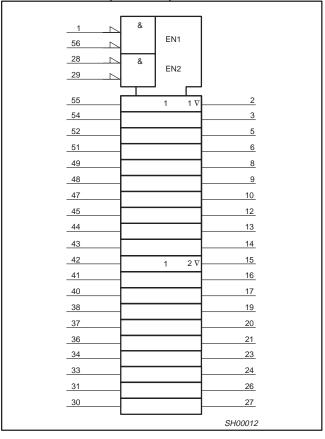
PIN CONFIGURATION



LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

TOROTION TABLE						
INPUTS		OUTPUTS	OPERATING MODE			
nOEx	nAx	nYx	OF ERATING MODE			
L	L	L	Transparent			
L	Н	Н	Transparent			
Н	Х	Z	High impedance			

Don't care

Ζ High impedance "off" state

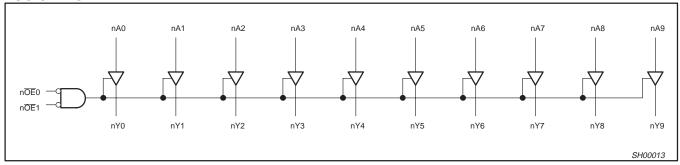
High voltage level

Low voltage level

20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		−0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
VI	DC input voltage ³		−1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	−0.5 to +5.5	V
	DC submit surrent	Output in Low state	128	mA
lout	DC output current	Output in High state	-64	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWIBUL	PARAMETER	MIN	MAX	UNIT
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δν	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

20-bit buffer/line driver, non-inverting (3-State)

DC ELECTRICAL CHARACTERISTICS

			LIMITS						
SYMBOL	PARAMETER	TEST CONDITIONS		T _{amb} = +25°C			T _{amb} = -40°C to +85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	1
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$			-0.9	-1.2		-1.2	V
		$V_{CC} = 4.5V; I_{OH} = -3mA; V_{I} = V$	_{IL} or V _{IH}	2.5	2.9		2.5		V
V_{OH}	High-level output voltage	$V_{CC} = 5.0V; I_{OH} = -3mA; V_{I} = V$	_{IL} or V _{IH}	3.0	3.4		3.0		V
		$V_{CC} = 4.5V; I_{OH} = -32mA; V_{I} = V_{I}$	V _{IL} or V _{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	$V_{CC} = 4.5V$; $I_{OL} = 64mA$; $V_{I} = V$	IL or VIH		0.42	0.55		0.55	V
ΙĮ	Input leakage current	$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$			±0.01	±1.0		±1.0	μΑ
		$V_{CC} = 5.5V; V_I = 5.5V$			0.01	1		1	μΑ
lı	Input leakage current	$V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND	Control pins		±0.01	±1		±1	μА
	74ABTH16827A	$V_{CC} = 5.5V$; $V_I = V_{CC}$	Data pins ⁴		0.01	1		1	μΑ
		$V_{CC} = 5.5V; V_I = 0$	Data pins		-1	-3		- 5	μΑ
	D 11.11	$V_{CC} = 4.5V; V_I = 0.8V$		35			35		
I _{HOLD}	Bus Hold current A inputs ⁵ 74ABTH16827A	$V_{CC} = 4.5V; V_I = 2.0V$		-75			-75		μΑ
		$V_{CC} = 5.5V$; $V_I = 0$ to 5.5V		±800					
I _{OFF}	Power-off leakage current	$V_{CC} = 0.0V; V_{O} = 4.5V; V_{I} = 0V$	or 5.5V		±5.0	±100		±100	μΑ
I _{PU} /I _{PD}	Power-up/down 3-State output current ³	$V_{CC} = 2.1V; V_{O} = 0.5V; V_{I} = GI$ $V_{OE} = Don't care$	ND or V _{CC} ;		±5.0	±50		±50	μА
I _{OZH}	3-State output High current	$V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL}$	or V _{IH}		1.0	10		10	μΑ
I _{OZL}	3-State output Low current	$V_{CC} = 5.5V$; $V_{O} = 0.5V$; $V_{I} = V_{IL}$	or V _{IH}		-1.0	-10		-10	μΑ
I _{CEX}	Output High leakage current	$V_{CC} = 5.5V; V_O = 5.5V; V_I = GI$	ND or V _{CC}		1.0	50		50	μА
ΙO	Output current ¹	V _{CC} = 5.5V; V _O = 2.5V		-50	-70	-180	-50	-180	mA
I _{CCH}		$V_{CC} = 5.5V$; Outputs High, $V_{I} = GND$ or V_{CC}			0.5	1		1	mA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V_I = GND or V_{CC}			9	19		19	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3-State; V_{I} = GND or V_{CC}			0.5	1		1	mA
ΔI_{CC}	Additional supply current per input pin ²	V_{CC} = 5.5V; one input at 3.4V, other inputs at V_{CC} or GND			0.2	1		1	mA

NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
 This is the increase in supply current for each input at 3.4V.
 This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10% a transition time of up to 100µsec is permitted.
 Unused pins at V_{CC} or GND.
 This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS

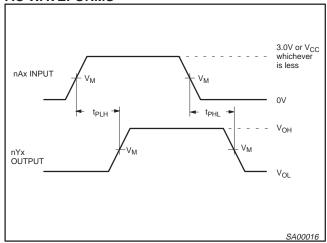
GND = 0V, $t_R = t_F = 2.5 \text{ns}$, $C_L = 50 \text{pF}$, $R_L = 500 \Omega$

			LIMITS					
SYMBOL PARAMETER		WAVEFORM	T _{amb} = +25°C V _{CC} = +5.0V			T _{amb} = -40 to +85°C V _{CC} = +5.0V ±0.5V		UNIT
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay nAx to nYx	1	1.0 0.6	1.7 1.4	2.4 2.0	1.0 0.6	2.7 2.3	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	2	1.0 1.0	3.0 3.0	4.1 4.0	1.0 1.0	5.0 5.0	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	2.0 1.6	3.2 2.4	4.3 3.2	2.0 1.6	5.0 3.5	ns

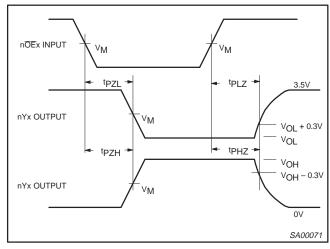
20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

AC WAVEFORMS

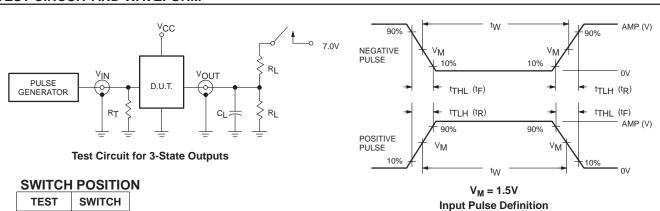


Waveform 1. Input (nAx) to Output (nYx) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORM



TEST	SWITCH
t _{PLZ}	closed
t _{PZL}	closed
All other	open

DEFINITIONS

 R_L = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$ capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

 $R_T = Termination resistance should be equal to <math>Z_{OUT}$ of pulse generators.

FAMILY	INPUT PULSE REQUIREMENTS						
PAWILI	Amplitude	Rep. Rate	t _W	t_{R}	t _F		
74ABT/H16	3.0V	1MHz	500ns	2.5ns	2.5ns		

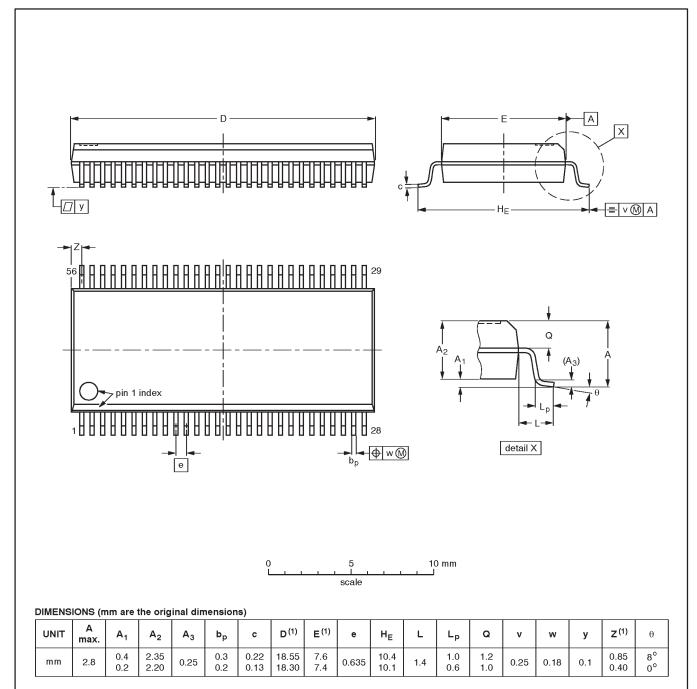
SA00018

20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



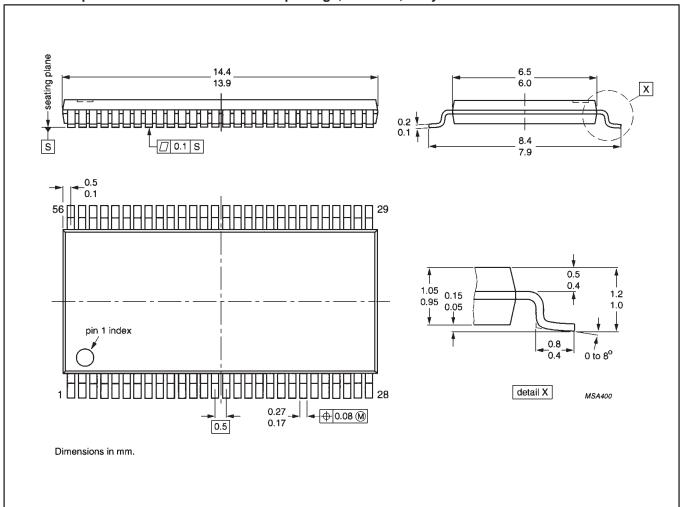
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERENCES			EUROPEAN	ICCUIE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT371-1		MO-118AB				93-11-02 95-02-04

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

NOTES

20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A 74ABTH16827A

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code Date of release: 05-96

Document order number: 9397-750-03504

Let's make things better.

Philips Semiconductors



